The University of Michigan College of Engineering Curriculum Committee

Agenda November 5, 2002 1:30-3:30 p.m. GM ROOM Fourth Floor Lurie Engineering Center

- 1. Approval of Minutes from October 1, 2002 Meeting
- 2. Presentation on CEE Concentrations Revisited—Will Hansen
- 3. Discussion on Math & Science Liaisons
- 4. Discussion 400 & 500 Level Courses Memo from Earl Lewis (Rackham Dean)
- 5. Course Approval Forms

University of Michigan College of Engineering Curriculum Committee Meeting Tuesday, October 1, 2002 1:30-3:00 p.m. Lurie Engineering Center GM Room Minutes

Armin Troesch called the meeting to order at 1:40 p.m.

Members Present: A. Troesch, E. Chan, J. Fessler, P. Friedmann, W. Hansen, G. Herrin, J.Holloway, G. Hulbert, S. Montgomery, B. Noble, S. Pang, H. Peng, R. Robertson, P. Samson, S. Takayama

Members Absent: B. Martin (IOE)

Guest: Henia Kamil

Armin Troesch welcomed Brian Noble (EECS—Computer Science & Engineering)

Addition to Minutes of 9-17-02

The minutes of the last meeting were approved.

Armin Troesch noted that at the September 17 meeting it was decided to add the word 'otherwise' to the beginning sentence third item under **Definitions and Exceptions** College of Engineering Humanities and Social Sciences document, and to the minutes from that meeting. The paragraph will read: **Otherwise**, courses that are designated as "BS", "CE", "MSA", "QR", "experiential", "directed reading or independent study", or course titles that include the terms or partial phrases "composition", "math", "outreach", "performance", "physics", "practicum", "statistics", studio", "tutor" may not be used to satisfy this requirement.

Will Hansen Presentation on CEE Concentrations—Revisited

Will Hansen passed out a paper noting concerns within the BSE CEE Degree Program:

Concentrations within the BSE CEE Degree Program

The student has the option to select from one of six concentrations offered in the undergraduate program. The concentration will appear on the student's transcript. The typical BSE degree requires the student to select 9 hours of Technical Electives consisting of two technical electives from the list (p.114). The remaining Technical Elective must be taken from the above list outside of the chosen *focus* area. A **Concentration** requires selecting one additional course in this sequence with a total of 12 credit hours in the Technical Concentrations list. The additional course reduces the requirements for Unrestricted Electives from 12 hours for the typical BSE degree to 9 hours if a **Concentration** is selected, thereby maintaining a total of 128 credit hours required for the BSE degree.

Peretz Friedmann asked if this was giving students too much freedom. "Focus" is required – "Concentration" optional.

It was decided to not vote on this at this time, and Will Hansen was asked to go back to the CEE Department with this for revision.

SGUS Discussion with Stella Pang

Stella Pang passed out information on the Sequential Graduate Undergraduate Study Program. Stella noted that this information was presented to the CoE CC in 2000. This also was presented to the graduate chairs in May of this year. Nothing has changed in this proposal, she just wanted to clarify this. Unlike the old program, dual enrollment (undergrad and grad program) is not needed. Students need to be admitted to Rackham and pay the Rackham fee. The student applies during the last year of their undergrad study.

Stella would like the double counted courses to be on the student's transcript. Jeanne Murabito said that would be unlikely, since only one other school does that.

Discussion: Sequential VS Simultaneous – Stella said that sequential is a better description. Since many courses are for 4 credit hours, not 3, should the maximum undergrad hours be changed from 6 to 8? This is hindering the student's progress in the SGUS Program.

Rackham is open to a proposal from the CoE Curriculum Committee and Stella will present a proposal to Rackham.

Jeanne Murabito said this could come to the CoE CC but the advisors should be the ones to make the proposal.

Armin Troesch said that at least eight students have had to get waivers from 6 to 8 credit hours. This could be worded as: 8 credit hours or two classes.

Additional Discussion Items

Levi Thompson has asked the CoE CC to become more pro-active with ABET assessment than in the past. He gave a handout and asked for comments to be entered in the minutes of the meeting.

1. Discussion on Role of Math & Science Liaison

• Should CoE support liaisons?

It would be good to hear from people who were liaisons in the past. The consensus was that the College of Engineering will recommend one or two liaisons after hearing opinions from Phil Savage and Nik Katapodes.

2. Discussion of Increased Communication Between the Two Colleges

Value to CoE and LS&A?

The question was asked whether the College of Engineering receives LS&A CC minutes and vice versa? No, but this is a good first step. It was asked if there would be interest in the CoE CC if the LS&A minutes were available. It was suggested that Judy could post them on Work Tools or on the CoE CC Website.

3. Department Level ABET Compliance Report

• How are term end course reports treated?

AOSS – No ABET program – efficient but informal assessment.

BIO MED E – Questionnaire, and faculty gets together for yearly review.

CEE -Recently created an assessment committee.

CHEM E – Yearly and reviewed – gets assessments and undergrad committee reviews.

CS (of EECS) – Forms are filled out by faculty members

EE (of EECS) – Forms are filled out by faculty members

IOE – Faculty peer inventory process. Sit in on classes and do assessment twice yearly.

INTER PRO – not ABET / not academic department

ME – Course leader and yearly report

MSE - Faculty Committee

NAVAL - Yearly

NERS – Assessment is continuous.

4. Assessment of Math & Science Courses Consistent With CoE Implementation of ABET

• Is this necessary?

Yes

Who should do the assessment?

The liaison should do the assessment and report back to the CoE CC. This will be a discussion item at the Joint CC meeting with LS&A.

5. How has ABET driven curriculum changes in your departments?

• Has the ABET Process Made a Difference?

Some yes, some no. On the positive side: Consistency of courses has improved, ownership of courses, more conversations on teaching.

Adjournment: Motion to adjourn was made and seconded

Motion carried (approved)

Next Meeting

Tuesday, October 22, 2002 – Joint Curriculum Committee Engineering and LS&A – 3-5 p.m. Kuenzel Room, 1st Floor Michigan Union.

Tuesday, November 5, 2002 1:30-3:30 p.m. GM Room-LEC



University of Michigan Horace H. Rackham School of Graduate Studies

Memorandum

To:

Department Chairs, Graduate Chairs, and Program Directors

From:

Earl Lewis &L

Vice Provost for Academic Affairs - Graduate Studies and

Dean of the Rackham Graduate School

Date:

May 21, 2002

Subject:

500 and 400 Level Courses

Rackham guidelines state that 500 level courses are primarily for first-year graduate students. Senior majors may take them, too, or others by special permission. It has come to my attention recently that in a number of Rackham departments, significant numbers of undergraduates have been enrolling in 500 level graduate classes. To illustrate, in Winter term, 2001, nineteen classes across ten departments, with class enrollments that ranged from 16 to 56, were made up of between 50% and 100% undergraduates. In some cases, this may be due to a lack of familiarity with Rackham guidelines for graduate course approval. Also, it's fairly common for advanced undergraduates to enroll in 500 level classes. However, I am concerned at how the nature of a 500 graduate level course might be affected by the enrollment of large percentages of undergraduates and am writing because I assume you may share that concern.

In addition and on a related topic, I want to take this opportunity to reiterate Rackham guidelines with respect to allowing graduate students to earn credit for undergraduate courses. Classes at the 400 level are primarily for undergraduates. Many 400 level courses, however, have been approved for both undergraduate and graduate credit. Appropriately, Rackham entrusts the faculty with responsibility for ensuring that graduate level work will be required of all graduate students who enroll in such courses. In some cases, the course material is at the graduate level for all students. In other cases, graduate students are required to do additional work beyond what is required of undergraduates enrolled in the course.

The Rackham guidelines for course approval, which were recently reviewed and affirmed by the Rackham Executive Board, are available in their entirety at http://www.rackham.umich.edu/Departments/ (see Guidelines for Graduate Course Approval). Please share the information in this memo with department and program faculty. If you have any questions or concerns, please communicate them to Glenda Haskell, Assistant to the Dean for Academic Programs and Services (haskell@umich.edu or 647-7548).

COURSE APPROVAL FORMS

November 5, 2002

AERO 365	New Course
EECS 370	Modification – Changing Pre-Reqs
EECS 401	Modification—Credit Restrictions
EECS 470	Modification—Changing Pre-Reqs
EECS 514	New Course
EECS 515	New Course

34 · 1

THE UNIVERSITY OF MICHIGAN -- COLLEGE OF ENGINEERING **Course Approval Request**

College Curriculum Committee, 1420 Lurie Engineering Center Building



Form Number

949

Action Requested

New Course
 Modification of Existing Course
 Deletion of Course

Complete the following sections:

New Courses - B & C completely

Modifications - A modified information, B & C completely

Deletions - A & C completely

Date 5/2/2002 Effective Winter 2003

	A. CL	JRRENT LISTING			B. R	EQUESTED L	ISTING		
	Home Depar	tment	Div#	Course Number	Home Dep Aerospace	ertment e Engineering		Div # 235	Course Number 365
	Cross Listed (Course Information			Cross Listed	Course Information			
	Course Title				Course Title	udies of Aerospac	ce Vehicles		
	TITLE	Time Sched Max = 19 Spaces			TITLE	Time Sched Max = 19 Spaces	Aero Veh Case	e Study	
	ABBRE- VIATION	Transcript Max = 20 Spaces			- ABBRE- VIATION	Transcript Max = 20 Spaces	Aero Veh Case	Study	
		RAM OUTCOMES:			Case str overviev and spa organiza	ription for Official Publication udies of notable a v of the trade-diag ce vehicles. Aere attional, business, RAM OUTCOM b	aerospace vehicle grams and desigr ospace system ir economic, and	n drivers of a ntegration in environmen	air, launch cluding tal issues.
	Degree Req	uirements O Degree Requirement	g h _	<u> </u>		auirements O Degree	Requirement O Tech Fle		
	Prerequisites	O Free Elective	O Other		Prerequisites	Core Co Free Ele Preceded or accompanie Enforced Adviso	ective ed by Aero 245 or permissi	on of instructor	
	Credit Restric		·		Credit Restri		eu		
	Level of Cre Undergrad Rackham Non-Rckhi Ugrad or F	only ☐ All Credit types Grad ☐ Rckhm Grad w/add m Grad	Credit Hours Min Max	Contact Hrs/Wk Number of Wks	Level of Cr Undergrad Rackham Non-Rckh Ugrad or I	Ionly □ All C Grad □ Rckh	redit types nm Grad w/add'l Work	Credit Hours Min Max 3 3	Contact Hrs/Wk 3 Number of Wks term
C.	Is this cours Maximur	epeatability (Indi Research, Dir. Study, Dis se repeatable? O Yes O No m Hours? Maximum Times? e repeated in the same term? O Yes O			Printing I	nformation Print the (Optional) Print the		lule	<u>.</u>
	Class Type(s)	Graded O Lec Lec Section O Rec Sem O Lab Lab O Dis Dis O Ind	Grading Lo	cation nn Arbor ological Station amp Davis xtension	Freq. of Offering Cognizant Fa Member:	Yearly Alter Years Culty C. Attach nomination if Cogni	■ Even Years ■ Odd \	/ears Title Profe	
] Faculty] Rackhai	um Comm. m sted Unit 1				Pept(s).	Pept. Cross-listed Dept) lai	n Boyd , Aero

Form Numbe	er
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The production of hardware is the final goal of practically all aerospace efforts. In the academic environment one may easily lose
This course will be a 3 credit hour design related course that may be part of a potential design thread or concentration throughout the curriculum. It will introduce the area of preliminary design as well as examples of detailed design.
Are any special resources or facilities required for this course?
Detail the Special requirements
It is strongly recommended that the faculty members responsible for this course actually have industrial project experience relating to flight hardware and that a field trip to view such hardware be made a part of the course

Aerospace Engineering 365

Case Studies of Aerospace Vehicles

Course Outline:

- 1. Aircraft (30%)
 - a. Harrier
 - b. Concorde
 - c. X-15
- 2. Missiles and Launch Vehicles (30%)
 - a. Sidewinder
 - b. Nova
- 3. Spacecraft (30%)
 - a. Pioneer
 - b. Lunar Excursion Module
- 4. Other Vehicles and components (10%)
 - a. Unmanned Air Vehicles (UAVs)
 - b. Wing in Ground Effect (WIGs)
 - c. Buoyant Vehicles, e.g. Balloons, Blimps
 - d. Ejection Seats
 - e. Manned Maneuvering Units (MMUS)
 - f. Spacesuits

References and Reading Material:

- 1. "Harrier," Francis K. Mason, Naval Institute Press, Annapolis, MD, 1983, ISBN 0870218298, Media Union Library: UG1242.F5 M371 1983.
- 2. "X-15 Diary: The Story of America's First Space Ship," Richard W. Tregaskis, Dutton, New York, 1961, Graduate Library.
- 3. The X-15 Research Airplane," NASA, Washington, DC, 1961, Media Union Library: TL 789.8.U6X5 A4 1961.
- 4. "Concorde," Philip Birtles, Shepperon, Ian Allan, 2000, ISBN 0711027404, Media Union Library: TL685.7.B57 2000.

- 5. "Sidewinder: Creative Missile Development at China Lake," Ronald Westrum, Naval Institute Press, Annapolis, MD, 1999, ISBN 1557509514, Graduate Library: UG1312.A6W471 1999.
- 6. "A History of Project Nova, 1959-1969," Parts I-III, Quest (a Quarterly Journal), Vol. 1, No. 3, Vol. 2, No. 1, Vol. 2, No. 2. On reserve in the Aero Library.
- 7. "New Cosmic Horizons: Space Astonomy from the V2 to the Hubble Space Telescope," David Leverington, Cambridge University Press, Cambridge, UK, ISBN 052165397, Science Library QB 136.L481 2000.
- 8. "Moon Lander: How We Developed the Apollo Lunar Module," T.J. Kelly, Smithsonian Institution Press, Washington, DC, 2001, ISBN 156098998X, Undergraduate Library: TL 795.K451 2001.
- 9. Selected NASA Mission Reports (available in Aero Library), e.g.,
 - a. Vangard A History," Green and Lomask, NASA SP-4202
 - b. "Gemini Summary Conference," NASA SP-138
 - c. "MoonPort: A History of Apollo Launch Facilities and Operations," Benson and Faherty, NASA SP-4202
 - d. "The Apollo Spacecraft: A Chronology," Ertel and Morse, NASA SP-4009
- 10. "Eject! Eject!," Bryan, Philpot Shepperton, Surrey, Ian Allen 1989, ISBN 0711018049, Media Union Library: TL 753.P5511 1989.
- "Airship Technology," edited by Gabriel A. Khoury and J. David Gillet, Cambridge Aerospace Series 10, Cambridge University Press, Cambridge, UK 1999, ISBN 0-521-43074-7, Aero Library TL 660.A37 1999.

Course Topics:

- 1. Component/system level design trades
- 2. System integration
- 3. Organizational, business, economic, and environmental aspects of an aerospace project

Course Objectives:

- 1. Introduce students to historical component and system level trades
- 2. Expose students to specific business and environmental aspect of aerospace systems
- 3. Learn from past successes and mistakes

Course Outcomes:

- 1. List significant milestones in aerospace technology (Assessed by: 1,2)
- Given a specification propose a potential derivative design (Assessed by: 1,2,3,4)
 Describe business, economic and other implications of design derivative
- (Assessed by: 1,2,3,4)
 4. Describe noticeable system failures (1,2)

Assessment Tools:

- Report
 Oral presentation
 Project
 Final exam

Aero 365: Case Studies or Aerospace Vehicles

COURSE #: 365	COURSE TITLE: CASE STUDIES OF AEROSPACE VEHICLES
TERMS OFFERED: Winter	PREREQUISITES: Aero 245 or permission of instructor
INSTRUCTOR(S): C.W. Kauffman	SCIENCE/DESIGN: 1/2
CATALOG DESCRIPTION: Case studies of notable aerospace vehicles and systems. An overview of the trade-diagrams and design drivers of air, launch and space vehicles. Aerospace system integration including organizational, business, economic, and environmental issues.	COURSE TOPICS: 1. Component/system level design trades 2. System integration 3. Organizational, business, economic, and environmental aspects of an aerospace project

COURSE OBJECTIVES*	 Introduce students to historical component and system level trades Expose students to specific business and environmental aspect of aerospace systems Learn from past successes and mistakes
COURSE OUTCOMES*	On completion of Aero 365, students can: 1. List significant milestones in aerospace technology (Assessed by: 1,2) 2. Given a specification propose a potential derivative design (Assessed by: 1,2,3,4) 3. Describe business, economic and other implications of design derivative (Assessed by: 1,2,3,4) 4. Describe noticeable system failures (1,2)
ASSESSMENT TOOLS	 Individual homework Hourly exams Project Final exam

THE UNIVERSITY OF MICHIGAN — COLLEGE OF ENGINEERING Course Approval Request

College Curriculum Committee, 1420 Lurie Engineering Center Building



Form Number

Action Requested

New CourseModification of Existing CourseDeletion of Course

Complete the following sections:

New Courses - B & C completely

Modifications - A modified information, B & C completely

Deletions - A & C completely

Date 9/27/2002

Effective Winter 2003

	A. CURRENT LISTING	B. REQUESTED LISTING
	Home Department Div # Course Number EECS 252 370	
	Cross Listed Course Information CS 353 370	Cross Listed Course Information
	Course Title Introduction to Computer Organization	Course Title Introduction to Computer Organization
	TITLE ABBRE-VIATION Transcript Intro Comp Organiz	TITLE Time Sched ABBRE- Intro Comp Organiz
_	Max = 20 Spaces Intr Comp Org	VIATION Transcript Max = 20 Spaces Intr Comp Org
	Course Description Basic concepts of computer organization and hardware. Instructions executed by a processor and how to use these instructions in simple assembly-language programs. Stored-program concept. Datapath and control for multiple implementations of a processor. Performance evaluation, pipelining, caches, virtual memory, input/output.	Course Description for Official Publication (Max = 50 words) Basic concepts of computer organization and hardware. Instructions executed by a processor and how to use these instructions in simple assembly-language programs. Stored-program concept. Datapath and control for multiple implementations of a processor. Performance evaluation, pipelining, caches, virtual memory, input/output.
	PROGRAM OUTCOMES:	PROGRAM OUTCOMES:
х	Core Course O Other Prerequisites EECS 280 or EECS 283 C Enforced © Advised	Core Course O Other Prerequisites (EECS 203 or EECS 270) and (EECS 280 or EECS 283)
	Credit Restrictions	© Enforced O Advised Credit Restrictions
	Level of Credit Undergrad only Rackham Grad Non-Rickhm Grad Ugrad or Rockhm Grad Ugrad or Non-Rickhm Grad Ugrad or Non-Rickhm Grad Ugrad or Non-Rickhm Grad Ugrad or Non-Rickhm Grad	Level of Credit Undergrad only
C.	Repeatability (Indi Research, Dir. Study, Dissertation: Is this course repeatable? Yes No Maximum Hours? Maximum Times? Can it be repeated in the same term? Yes No	Printing Information (Optional) Print the course in the Bulletin Print the course in the Time Schedule
	Class Type(s)	Terms & ■ ■ □ □ Half term □ 1st Freq. of □ 2nd
	Sem	Offering Yearly Alter Years Even Years Odd Years Cognizant Faculty Papaefthymiou, M. Title Assoc. Professor Member: Tyson, G. Asst. Professor Grad Course: Attach nomination if Cognizant Faculty is not a regular graduate faculty
	Curriculum Comm.	Submitted By: ■ Home Dept. □ Cross-listed Dept. Name, Signature & Department
	Faculty Rackham Cross listed Unit 1 Cross listed Unit 2	Home Dept. Jeff Fessler, EECS J.J. Tunk 200 i - 10 - 4

Form	Number
966	

SUPPORTING STATEMENT Students taking 370 need familiarity with Boolean algebra/logic which they can learn in either EECS 203 or EECS 270.

Are any special resources or facilities required for this course?

THE UNIVERSITY OF MICHIGAN - COLLEGE OF ENGINEERING Course Approval Request

College Curriculum Committee, 1420 Lurie Engineering Center Building



Form Number

Action Requested

New CourseModification of Existing CourseDeletion of Course

Complete the following sections:

New Courses - B & C completely

Modifications - A modified information, B & C completely

Deletions - A & C completely

Date 10/3/2002

Effective Winter 2003

	A. CURRENT LISTING	B. REQUESTED LISTING
	Home Department Div # Course Number EECS 252 401	Home Department Div # Course Number EECS 252 401
	Cross Listed Course Information	Cross Listed Course Information
	Course Title Probabilistic Methods in Engineering	Course Title Probabilistic Methods in Engineering
	TITLE ABBRE- Time Sched Prob Methods Engr	TITLE Time Sched ABBRE- Max = 19 Spaces Prob Methods Engr
	VIATION Transcript Max = 20 Spaces Prob Methods Engr	VIATION Transcript Max = 20 Spaces Prob Methods Engr
	Course Description Basic concepts of probability theory. Random variables: discrete, continuous and conditional probability distributions; averages; independence. Introduction to discrete and continuous random processes; wide sense stationarity, correlation, spectral density.	Course Description for Official Publication (Max = 50 words) Basic concepts of probability theory. Random variables: discrete, continuous and conditional probability distributions; averages; independence. Introduction to discrete and continuous random processes; wide sense stationarity, correlation, spectral density.
	PROGRAM OUTCOMES:	PROGRAM OUTCOMES:
	Degree Requirements	
Х	O Core Course O Free Elective Prerequisites	O Core Course O Free Elective Prerequisites EECS 306 or EECS 212/316 and Junior standing.
	Credit Restrictions credit for only one of EECS 401 and EECS 501	© Enforced ○ Advised Credit Restrictions credit for only one of EECS 401 and EECS 501
	Level of Credit ☐ Undergrad only ☒ All Credit types ☐ Credit Hours Contact ☐ Rackham Grad ☐ Rokhm Grad w/add'l Work Min Max Hrs/Wk 4 ☐ Ugrad or Rckhm Grad ☐ Ugrad or Non-Rckhm Grad Or Non-Rckhm Grad ☐ Ugrad or Non-Rckhm Grad Or Non-Rckhm Grad Or Non-Rckhm Grad Or Non-R	Level of Credit Undergrad only All Credit types Credit Hours Contact Rackham Grad Rckhm Grad W/add'l Work Min Max Hrs/Wk 4 Ugrad or Rockhm Grad Ugrad or Non-Rckhm Grad Ugrad or Non-Rckhm Grad Ugrad or Non-Rckhm Grad Of Wks 14
C.	Repeatability (Indi Research, Dir. Study, Dissertation: Is this course repeatable?	Printing Information Print the course in the Bulletin (Optional) Print the course in the Time Schedule
	Class Graded © Lec Grading Type(s) 🛮 Lec Section O Rec Location	Terms & ■ □ □
	Serm Serm A-E-CNVC Ann Arbor Lab CFUNC Ann Arbor Dis S/U Blological Station Ind Ind P/F Camp Davis Other Y Extension	Offering Yearly Alter Years Even Years Odd Years Cognizant Faculty W.E. Stark Title Professor Member: D. Teneketzis Professor D.J. Anderson Professor Grad Course: Attach nomination if Cognizant Faculty is not a regular graduate faculty
	Approval] Curriculum Comm.	Submitted By: ■ Home Dept. □ Cross-listed Dept. Name, Signature & Department
	Faculty	Home Dept. Jeff Fessler, EECS With 2002-10-16 Cross-listed Dept(s).

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SUPPORTING STATEMENT The continuous-time fourier transform covered in 306 is essential background for students taking EECS 401.	

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Are any special resources or facilities required for this course?	
Detail the Special requirements	
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To: CoE Curriculum Committee

From: Jeff Fessler, Chair, EECS curriculum committee

Date: Tue Oct 15 17:16:29 EDT 2002



Please find attached a course change form for EECS 401 and an associated EE program change.

On Sep. 10, 2002, the ECE faculty voted to require EECS 306 (Signals and Systems II) as a prerequisite for EECS 401 (Probabilistic methods in Engineering), because the material from EECS 306 is absolutely essential to EECS 401, and the existing prerequisite (EECS 206) is inadequate. Students need a junior level signals and systems course to be prepared for EECS 401. (In the old curriculum, EECS 316 was the prerequisite for EECS 401.)

However, EECS 306 is not a program subject in the EE degree, but is one of several Core Electives. So for those students who (for whatever reason) want to avoid both EECS 306 and EECS 401, we need to provide some method for them to fulfill their ABET probability requirement. We voted to allow students to have the option of taking Math 425 (Probability). However, Math 425 is not an EECS course and is only 3 credits, so to maintain the same number of EECS required courses (11), we voted on Oct. 15, 2002, to require that students who elect to take Math 425 rather than EECS 401 must take some other 300-level or higher EE course instead (i.e, an Upper Level EE elective). Here is a summary:

Current program (continues to be an option):

credits category 4 EECS 401

Flexible technical electives
Upper level EE electives

Option for students who choose Math 425:

credits category
3 Math 425

Flexible technical electives
Upper level EE electives

Essentially, students who choose Math 425 are using 3 of their flexible technical elective credits, and must find some other EE course to take instead of EECS 401.

It is our intention to also make it explicit in the bulletin that students cannot receive credit for more than one of EECS 401, Math 425, and IOE 265. This requires coordination of many curriculum committees and is in the works.

## OLD

Subjects req. by all programs (55 hrs.)	Hours	1	2	3	4	5	6	7	8
<i>I</i> Mathematics 115, 116, 215, & 216	16	4	4	4	4	-	-	-	-
ENGR 100	4	4	-	_	-	-	-	-	-
Chemistry 125/130 OR Chemistry 210 /211	5	5	-	-	-	-	-	-	-
ENGR 101	4	_	4	-	-	-	-	-	-
Physics 140 with Lab 141; Physics 240 with Lab 241	10	-	5	5	-	-	-	- 1	-
Humanities & Social Sciences	16	4	4	4	4	-	-	-	-
Program Subjects (27 hrs.)									
EECS 206, Signals and Systems	4	-	-	4	-	-	-	-	-
EECS 215, Introduction to Circuits	4	-	_	-	4	_	-	-	-
EECS 230, Electromagnetics I	4	-	-	-	-	4	-	-	-
EECS 280, Prog. and Elem. Data Struct.	4	_	-	-	4	-	-	-	-
EECS 320, Intro to Semico. Device Theory	4	-	_	· _	-	4	-	-	-
EECS 401, Probabilistic Methods in Engin.	4	-	-	-	-	-	4	-	-
2 TCHNCLCM 215	1	-	-	-	1	-	-	-	-
2 TCHNCLCM 496	2	-	-	-	-	_	-	-	2
Technical Electives (34 hrs.)									
3 Flexible Technical Electives	11	-	-	-	-	-	4	3	4
4 Core Electives	8	-	-	-	-	4	4	-	-
5 Upper Level EE Technical Electives	8	-	-	-	-	-	-	8	-
6 Major Design Experience	4	-	-	-	-	-	-	-	4
7 Engineering Breadth Elective	3	-	_	-	-	3	-	-	-
Free Electives (12 hrs.)	12	-	-	-	-	-	4	4	4
TOTAL	128	17	17	17	17	15	16	15	14

1 EE students are advised to take MATH 216 before MATH 215 since EECS 215 is to be preceded or accompanied by MATH 216

2 Technical Communication: TCHNCLCM 215 must be taken with EECS 215. TCHNCLCM 496 must be taken with a Major Design Experience (MDE) course.

3 Flexible Technical Electives: The flexible technical elective requirement may be fulfilled by taking selected courses in EECS, other engineering departments, biology, business, chemistry, economics, math, or physics. See the Undergraduate Advising Office for the current list. All other courses must be approved by an EE program advisor. 4 Core Electives: A least 8 credits from at least two categories: Signals and Systems (306), Circuits (311, 312), Electromagnetics/optics (330) or Computers (270,370).

5 Upper Level EE Technical Electives: EECS courses at the 300-level or higher, excluding EECS 499; at least 4 credits must be at the 400-level or higher. Excludes theoretical CS and software courses. See the EECS Undergraduate Advising Office for the current list.

6 Major Design Experience: Pre-approved courses: EECS 411, 425, 427, 430, 438, 452, 470, 497; other courses may be acceptable with prior approval of a Program Advisor.

7 Engineering Breadth Elective: a 200-level course required by another program in Engineering or a 300-level course in Engineering.

A maximum of 4 credits of EECS 499 may be applied to Technical Elective Requirements and only in the area of Flexible Technical Electives. Anything beyond 4 credits will be applied toward Free Electives.

## NEW

Subjects req. by all programs (55 hrs.)	Hours	1	2	3	4	5	6	7	8
1 Mathematics 115, 116, 215, & 216	16	4	4	4	4	-	_	-	
ENGR 100	4	4	-	-	-	    -	-	-	-
Chemistry 125/130 OR Chemistry 210 /211	5	5	-	ii -	-	-	-	-	-
ENGR 101	4	-	4	-	-	-	-	-	-
Physics 140 with Lab 141; Physics 240 with Lab 241	10	-	5	5	-		- -	-	
Humanities & Social Sciences	16	4	4	4	4	-	-	-	
Program Subjects (27 hrs.)			·	<b>*</b> }	i				
EECS 206, Signals and Systems	4	-	-	4	: <b>-</b>	-	-	-	
EECS 215, Introduction to Circuits	4	_	-	-	4	-	-	-	-
EECS 230, Electromagnetics I	4	-	-	    -	_	4	-	† -	
EECS 280, Prog. and Elem. Data Struct.	4	-	-	-	4	-	-	-	
EECS 320, Intro to Semico. Device Theory	4	_	-	-	-	4	-	<u> </u>	
8 EECS 401, Probabilistic Methods in Engin., or Math 425, Probability (3 cr)	4	-	-	-	-	-	4	-	
2 TCHNCLCM 215	1	-	-	-	1	-	- -	-	١.
2 TCHNCLCM 496	2	-	-	-	-	-	-	-	2
Technical Electives (34 hrs.)					:				
3 Flexible Technical Electives	11	-	-	-	-	-	4	3	
4 Core Electives	8	-	-	-	-	4	4	-	ļ
5 Upper Level EE Technical Electives	8	-	-	-	-	-	-	8	-
6 Major Design Experience	4	-	-	-	-	-	-	-	4
7 Engineering Breadth Elective	3	-	-	-	-	3	-	-	-
Free Electives (12 hrs.)	12	-	-	-	-	-	4	4	4
TOTAL	128	17	17	17	17	15	16	15	1

1 EE students are advised to take MATH 216 before MATH 215 since EECS 215 is to be preceded or accompanied by MATH 216

2 Technical Communication: TCHNCLCM 215 must be taken with EECS 215. TCHNCLCM 496 must be taken with a Major Design Experience (MDE) course.

3 Flexible Technical Electives: The flexible technical elective requirement may be fulfilled by taking selected courses in EECS, other engineering departments, biology, business, chemistry, economics, math, or physics. See the Undergraduate Advising Office for the current list. All other courses must be approved by an EE program advisor. 4 Core Electives: A least 8 credits from at least two categories: Signals and Systems (306), Circuits (311, 312), Electromagnetics/optics (330) or Computers (270,370).

5 Upper Level EE Technical Electives: EECS courses at the 300-level or higher, excluding EECS 499; at least 4 credits must be at the 400-level or higher. Excludes theoretical CS and software courses. See the EECS Undergraduate Advising Office for the current list.

6 Major Design Experience: Pre-approved courses: EECS 411, 425, 427, 430, 438, 452, 470, 497; other courses may be acceptable with prior approval of a Program Advisor.

7 Engineering Breadth Elective: a 200-level course required by another program in Engineering or a 300-level course in Engineering.

★ 8 Students who elect Math 425 (3cr) rather than taking EECS 401 are required to fulfill 8 credits of Flexible Technical Electives and 12 credits of Upper Level EE Technical Electives.
A maximum of 4 credits of EECS 499 may be applied to Technical Elective Requirements and only in the area of

Flexible Technical Electives. Anything beyond 4 credits will be applied toward Free Electives.

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1 of 1

# THE UNIVERSITY OF MICHIGAN – COLLEGE OF ENGINEERING Course Approval Request

College Curriculum Committee, 1420 Lurie Engineering Center Building

Print

Form	Number
967	

#### Action Requested

New CourseModification of Existing CourseDeletion of Course

Complete the following sections:

New Courses - B & C completely

Modifications - A modified information, B & C completely

Deletions - A & C completely

**Date** 9/30/2002 **Effective** Winter 2003

	A. CURRENT LISTING		В. <b>R</b>	EQUESTED LI	STING					
	Home Department EECS	Div # Course Number 252 470	Home Dep			Div #	Course Number			
	Cross Listed Course Information CS (LSA)	353 470	Cross Listed CS (LSA)	Course Information		353	470			
	Course Title Computer Architecture		Course Title Computer Architecture							
	TITLE	е	TITLE ABBRE- VIATION	Time Sched Max = 19 Spaces Transcript	Comp Architec	cture				
	Course Description Basic Concepts of computer architecture and Computer evolution. Design methodology. P evaluation. Elementary queuing models. CPU instruction sets. ALU design. Hardwared and control. Nanoprogramming memory hierarchie Cache design. Input-output architectures. Interprocessors. Parallel processing pipelined pro Multiprocessors.	erformance I architecture microprogrammed es. Virtual memory. erupts and DMA. I/O	Course Description for Official Publication (Max = 50 words)  Basic Concepts of computer architecture and organization.  Computer evolution. Design methodology. Performance evaluation. Elementary queuing models. CPU architecture instruction sets. ALU design. Hardwared and microprogrammed control. Nanoprogramming moment histographics. Virtual manners							
	PROGRAM OUTCOMES:  ⊠ a ⋈ b ⋈ c □ d ⋈ e □ f □ g □  Degree Requirements O Degree Requirement O Tech Elective O Core Course O Other	h □i □j ⊠k	PROGRAM OUTCOMES:							
х	Prerequisites EECS 370 or Graduate Standing  © Enforced © Advised		O Core Course O Other  Prerequisites EECS 370, EECS 270 or Graduate Standing. ⊙ Enforced ○ Advised							
	Credit Restrictions none  Level of Credit		Credit Restrictions none							
	Undergrad only All Credit types Arackham Grad Rokhm Grad Wadd'l Work Min Ugrad or Rokhm Grad Ugrad or Non-Rokhm Grad Ugrad or Non-Rokhm Grad 4	Max  Max  Number of Wks 14	Level of Cru  ☐ Undergrad ☐ Rackham (☐ Non-Rckhr  ☒ Ugrad or R ☐ Ugrad or N	only 🗆 All Crea Grad 🗀 Rokhm m Grad	dit types Grad w/add'i Work	Credit Hours Min Max 4 4	Contact Hrs/Wk 4  Number of Wks 14			
C.	Repeatability (Indi Research, Dir. Study, Dissertation: Is this course repeatable?		Printing In	oformation   ⊠ Print the co Optional)  ⊠ Print the co	ourse in the Bulletin ourse in the Tirne Schedu	ule				
	Class   Type(s)   Lec   Graded   Section   Rec   Rec   Sem   Lab   CRNC   Lab   CRNC   Dis   Dis   Did   P/F   Other   Other   Y	Location  Ann Arbor Biological Station Camp Davis Extension	Terms & IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII							
	Approval  Curriculum Comm.		Name, Signature	·	1111					
	Raculty Rackham Cross listed Unit 1 Cross listed Unit 2		Home De  Cross-listed De		os Hr		-60-4			

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967	

Students taking 470 have always needed the material in 270. This background used to be automatic when 370 had 270 as a
prerequisite. Now that 370 does not require 270 absolutely, the 270 prerequisite for 470 needs to be made explicit.
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SUPPORTING STATEMENT

Are any special resources or facilities required for this course?	☐ Yes ☐ No
Detail the Special requirements	
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# THE UNIVERSITY OF MICHIGAN - COLLEGE OF ENGINEERING Course Approval Request

College Curriculum Committee, 1420 Lurie Engineering Center Building



F	or	m	Number
9	6	9	

#### Action Requested

New CourseModification of Existing CourseDeletion of Course

#### Complete the following sections:

New Courses - B & C completely

Modifications - A modified information, B & C completely

Deletions - A & C completely

Date <u>10/1/2002</u>

Effective <u>Winter 2003</u>

	A. CURRENT LISTING	B. REQUESTED LISTING							
	Home Department Div # Course Number	Home Department Div # Course Number EECS 252 514							
	Cross Listed Course Information	Cross Listed Course Information							
	Course Title	Course Title Advanced MEMS Devices and Technologies							
	TITLE	TITLE ABBRE- VIATION Transcript Max = 20 Spaces  Time Sched Max = 19 Spaces Advanced MEMS Advanced MEMS Advanced MEMS							
	Course Description	Course Description for Official Publication (Max = 50 words) Advanced micro electro mechanical systems (MEMS) devices and technologies. Transduction techniques, including piezoelectric, electromagnetic, electrothermal, and resonant techniques. Chemical, gas, and biological sensors, microfluidic and biomedical devices. Micromachining technologies such as laser machining and microdrilling, EDM, materials such as SiC and diamond. Sensor and actuator analysis and design through CAD.							
	PROGRAM OUTCOMES:  a b c d e f g h i j k  Degree Requirements O Degree Requirement O Tech Elective O Other	PROGRAM OUTCOMES:  a b c d e f g h i j k  Degree Requirements O Degree Requirement O Tech Elective							
	O Free Elective Prerequisites	O Core Course O Free Elective  Prerequisites EECS 414							
=	○ Enforced ○ Advised	⊕ Enforced ○ Advised							
	Credit Restrictions	Credit Restrictions Four Credits Only, None							
	Level of Credit  Undergrad only Rackham Grad Rockham Grad w/add'l Work Ugrad or Rockham Grad Ugrad or Rockham Grad Ugrad or Non-Rockham Grad Ugrad or Non-Rockham Grad	Level of Credit  Undergrad only  All Credit types  Rackham Grad Rokhm Grad Non-Rokhm Grad Ugrad or Non-Rickhm Grad Ugrad or Non-Rickhm Grad Ugrad or Non-Rickhm Grad  Ugrad or Non-Rickhm Grad Ugrad or Non-Rickhm Grad							
C.	Repeatability (Indi Research, Dir. Study, Dissertation:  Is this course repeatable?	Printing Information (Optional)  Print the course in the Bulletin Print the course in the Time Schedule							
	Class Type(s)    Lec   Section   Rec   Rec   Section   Rec   Location	Terms &							
	Approval  Curriculum Comm.  Faculty	Submitted By: ■ Home Dept. □ Cross-listed Dept.  Name, Signature & Department  Home Dept. EECS Jeff Fessler  Cross-listed Dept(s).							
	Rackham Cross listed Unit 1 Cross listed Unit 2	[·							

Form Number	
969	

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J			_ ,	_	п		R L	v	u				_	IVI		11	4 2	

This course is a continuation of EECS 414, which introduces students to the general area of micro electro mechanical systems. This course will cover advanced topics dealing with MEMS technologies, transduction mechanisms, and microfabricated sensors and actuators. Many emerging micromachining technologies such as laser and micromechanical machining, and non-conventional materials such as SiC and diamond will be discussed and reviewed. Transduction techniques, including electromagnetic, piezoelectric, resonant, electrothermal, electrostrictive, electro-hydrodynamic etc., will be discussed and reviewed. The course will review different types of sensors for measurement of physical parameters such as acceleration, rotation rate, pressure, and different micro actuators. Details on how these devices are fabricated, and analyzing their performance will be presented. The course will also review MEMS for use in microfluidics and in biomedical applications, and will review basic fundamental fluid mechanics and issues involved in microfluidic systems. It will review chemical and gas sensors, as well as biosensors.  Above topics will be presented in a complementary fashion to what is covered in EECS 414. The course will meet in lectures and will incorporate a major project where students will team up to design/analyze micromachined sensors/actuators using CAD tools.
Are any special resources or facilities required for this course?  Detail the Special requirements

## EECS 514: Advanced MEMS Devices and Technologies

**Pre-requisites:** EECS 414 **Term Offered:** Winter, Yearly

Credits: Four

This course is a continuation of EECS 414, which introduces students to the general area of micro electro mechanical systems. This course will cover advanced topics dealing with MEMS technologies, transduction mechanisms, and microfabricated sensors and actuators. Many emerging micromachining technologies such as laser and micromechanical machining, and non-conventional materials such as SiC and diamond will be discussed and reviewed. Transduction techniques, including electromagnetic, piezoelectric, resonant, electrothermal, electrostrictive, electro-hydrodynamic etc., will be discussed and reviewed. The course will review different types of sensors for measurement of physical parameters such as acceleration, rotation rate, pressure, and different micro actuators. Details on how these devices are fabricated, and analyzing their performance will be presented. The course will also review MEMS for use in microfluidics and in biomedical applications, and will review basic fundamental fluid mechanics and issues involved in microfluidic systems. It will review chemical and gas sensors, as well as biosensors.

Above topics will be presented in a complementary fashion to what is covered in EECS 414. The course will meet in lectures and will incorporate a major project where students will team up to design/analyze micromachined sensors/actuators using CAD tools.

#### Course Syllabus

#### • MEMS fabrication and materials (4 lectures)

Review of micromachining with emphasis on new techniques; 3-D machining techniques, drilling, milling, EDM, laser machining; Non-silicon materials, SiC, poly-diamond, polymers, etc.

#### 1) Magnetic Electromagnetic transducers (4 lectures)

Measurement of magnetic fields, Hall-effect sensors, magnetoresistive sensors, integrated magnetic sensors, flux-gate magnetometers, magnetic-field measurement using integrated transistor structures, other magnetic sensors, electromagnetic actuators

#### • Piezoelectric transducers (4 lectures)

Review of piezoelectric property and important characteristics; piezoelectric sensors, piezoelectric actuators

#### 1) Resonant devices (4 lectures)

Introduction to mechanical resonance, basic review of analysis techniques, review of resonant modes, resonant sensors, review of resonant actuators, introduction to RF MEMS

#### 1) Other transduction techniques (2 lectures)

Electrostrictive, electro-hydrodynamic, electrothermal, and other less frequently used techniques.

#### • Chemical/gas and biological sensors (6 lectures)

Chemical sensors, electrochemical transducers, implantable sensing systems, gas sensors, chemical analysis systems, biosensors, Palladium-gate hydrogen sensors; thin-film conductivity-based devices for gas measurement; Ion-sensitive FET ion concentration sensors;

## • Microfluidic microsystems (4 lectures)

Introduction to fluid mechanics; Microfluidic devices such as inkjet heads, gene analysis chips, microfluidic system issues, fluidic valves, pumps, etc.

Cognizant faculty: Gianchandani, Najafi, Nguyen, Pang, Wise

## THE UNIVERSITY OF MICHIGAN - COLLEGE OF ENGINEERING Course Approval Request

College Curriculum Committee, 1420 Lurie Engineering Center Building



Form	Number
970	

#### Action Requested

New CourseModification of Existing CourseDeletion of Course

## Complete the following sections:

New Courses - B & C completely

Modifications - A modified information, B & C completely

Deletions - A & C completely

Date 10/1/2002

Effective Winter 2003

	A. CURRENT LISTING	B. REQUESTED LISTING
	Home Department Div # Course Number	Home Department Div # Course Number EECS 252 515
	Cross Listed Course Information	Cross Listed Course Information
	Course Title	Course Title Integrated Microsystems
	TITLE	TITLE ABBRE- VIATION Time Sched Max = 19 Spaces Integ. Microsystems Integ. Microsystems Integ. Microsystems
	PROGRAM OUTCOMES:  a b c d e f g h i j k	Course Description for Official Publication (Max = 50 words) Review of interface electronics for sense and drive and their influence on device performance, interface standards, MEMS and circuit noise sources, packaging and assembly techniques, testing and calibration approaches, and communication in integrated microsystems. Applications, including RF MEMS, optical MEMS, bioMEMS, and microfluidics. Design project using CAD and report preparation.
	Degree Requirements O Degree Requirement O Tech Elective O Core Course O Free Elective	Degree Requirements O Degree Requirement O Tech Elective O Core Course O Other
	Prerequisites  © Enforced © Advised	O Free Elective  Prerequisites EECS 414  ⊕ Enforced ⊕ Advised
	Credit Restrictions	Credit Restrictions Four Credits Only, None.
	Level of Credit Undergrad only	Level of Credit  Undergrad only Rackham Grad Rokhm Grad w/add'l Work Non-Rokhm Grad Ugrad or Non-Rokhm Grad
C.	Repeatability (Indi Research, Dir. Study, Dissertation: Is this course repeatable?	Printing Information
	Class Type(s)  Lec Serion  Rec  Sem  Lab  Lab  Dis  Ind  Other  Other  Class  Craving  Location  Craving  Craving  Biological Station  Cother  Other  Camp Davis  Extension	Terms & I I I I I I I I I I I I I I I I I I
	Curriculum Comm.  Faculty Rackham Cross listed Unit 1 Cross listed Unit 2	Name, Signature & Department  Home Dept. EECS Jeff Fessler # Turk 2007-10-9  Cross-listed Dept(s).

Form	Number
970	

SUPPORTING STATEMEN
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This course will cover advanced topics in micromachined sensors, actuators, and microsystems. It will concentrate on issues specific to microsystems, which include MEMS, interface electronics, noise sources, packaging, testing and communication. It will also discuss applications of microsystems, including RF MEMS, optical MEMS, bioMEMS. The course will specifically address some of the performance limits in microsystems: the influence of sensor performance and noise, the impact of interface electronic performance and noise, and the overall impact of system package and assembly on noise. The course will review different sensing circuits and their performance specifications. In addition, topics such as system architecture, packaging, testing and calibration, and wireless communication will be discussed in the context of several application areas. The course will discuss several of the emerging application areas and will review case studies of some of these application areas.
The course will meet in lectures and will also include a major design project where teams of students will
carry out a project of their choice from beginning to end.
<del></del>
Are any special resources or facilities required for this course?
Detail the Special requirements

#### Courses in MEMS and Microsystems at Michigan

## EECS 515: Integrated Microsystems

**Pre-requisites:** EECS 414, (EECS 311 is recommended)

**Term Offered:** Fall, Yearly

**Credits:** Four

This course will cover advanced topics in micromachined sensors, actuators, and microsystems. It will concentrate on issues specific to microsystems, which include MEMS, interface electronics, noise sources, packaging, testing and communication. It will also discuss applications of microsystems, including RF MEMS, optical MEMS, bioMEMS. The course will specifically address some of the performance limits in microsystems: the influence of sensor performance and noise, the impact of interface electronic performance and noise, and the overall impact of system package and assembly on noise. The course will review different sensing circuits and their performance specifications. In addition, topics such as system architecture, packaging, testing and calibration, and wireless communication will be discussed in the context of several application areas. The course will discuss several of the emerging application areas and will review case studies of some of these application areas.

The course will meet in lectures and will also include a major design project where teams of students will carry out a project of their choice from beginning to end.

#### Course Syllabus

#### • Review of noise and loss mechanisms in MEMS (3 lectures)

Electrical noise sources and analysis, dissipative processes, non-electrical noise sources

#### • Readout circuits (4 lectures)

For capacitive, piezoresistive, resonant, and other transducers. Comparison of different circuits, and impact of circuit on overall device performance, modulation and filtering techniques, etc.

#### • Drive circuits (3 lectures)

Review of circuits and systems needed in micro-actuators and closed-loop systems, feedback techniques

#### • Detection limits (4 lectures)

Analysis of fundamental limits in measurement systems, review of issues that affect system reliability, accuracy, and stability; temperature sensitivity issues.

## • Review of example micromachined instruments (3 lectures)

Use examples such as micro-machined gas chromatography, spectrum analyzers, micromachined filters, etc.

#### • Testing and Calibration (3 lectures)

Review of issues related to sensors testing and calibration, compensation and trimming techniques, digital compensation and use of micro-controllers to improve overall performance, cost and yield analysis

#### • Packaging (4 lectures)

Review of packaging issues, and basic MEMS-based packaging techniques. Effect of package on device performance, packaging techniques to minimize impact on device performance,

## • System architecture, integration, and partitioning issues (4 lectures)

System partitioning, overall performance and effects of packaging, standards, wireless communication

Cognizant faculty: Gianchandani, Najafi, Nguyen, Pang, Wise